COMPLIANT

HALOGEN

**FREE** 



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# Vishay Siliconix

# N-Channel 80 V (D-S) MOSFET



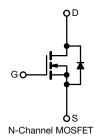
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	80			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0156			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.0203			
Q <sub>g</sub> typ. (nC)	9.5			
I <sub>D</sub> (A)	33.7			
Configuration	Single			

#### **FEATURES**

- TrenchFET® Gen IV power MOSFET
- Very low R<sub>DS</sub> x Q<sub>g</sub> figure-of-merit (FOM)
- Tuned for the lowest R<sub>DS</sub> x Q<sub>oss</sub> FOM
- 100 % R<sub>a</sub> and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- · Synchronous rectification
- · Primary side switch
- DC/DC converter
- · Motor drive control
- · Load switch



ORDERING INFORMATION	
Package	PowerPAK 1212-8
Lead (Pb)-free and halogen-free	SiS128LDN-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	80	V	
Gate-source voltage		$V_{GS}$	± 20	v	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		33.7		
	T <sub>C</sub> = 70 °C	1 .	26.9		
	T <sub>A</sub> = 25 °C	l <sub>D</sub>	10.2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	†	8.3 b, c	Δ.	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	70	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	35.4		
	T <sub>A</sub> = 25 °C		3.2 b, c		
Single pulse avalanche current	l 0.1 mll	I <sub>AS</sub>	15		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	11.25	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		39		
	T <sub>C</sub> = 70 °C	P <sub>D</sub>	25	w	
	T <sub>A</sub> = 25 °C		3.6 b, c	VV	
	T <sub>A</sub> = 70 °C		2.4 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) <sup>c</sup>			260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	$R_{thJA}$	26	34	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	2.4	3.2		

- Package limited
- b. Surface mounted on 1" x 1" FR4 board
- t = 10 s
- See solder profile (<a href="https://www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 81 °C/W
- $T_C = 25 \, ^{\circ}C$

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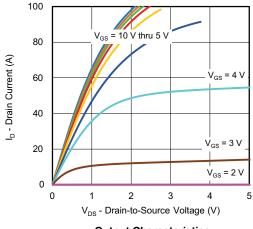
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	80	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	64	-	1400	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_{J}$	I <sub>D</sub> = 250 μA	-	-4.6	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	-	2.5	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	100	nA	
<u> </u>	466	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V	-	-	1	μА	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	_	15		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	40	-	-	Α	
Drain-source on-state resistance <sup>a</sup>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	0.0130	0.0156	+ '`	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A	_	0.0169	0.0203	Ω	
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A	_	30	-	S	
Dynamic b	315	DO - 7-0			<u> </u>		
Input capacitance	C <sub>iss</sub>		T -	1250	_	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	127	-		
Reverse transfer capacitance	C <sub>rss</sub>		_	7.8	-		
	_	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	20	30		
Total gate charge	Qg	$V_{DS} = 40 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	9.5	14.5	nC	
Gate-source charge	Q <sub>gs</sub>		-	3.8	-		
Gate-drain charge	Q <sub>gd</sub>		-	2.8	-		
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V	-	16.8	-		
Gate resistance	$R_{g}$	f = 1 MHz	0.3	0.87	1.5	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	10	20	_	
Rise time	t <sub>r</sub>	$V_{DD}$ = 40 V, $R_L$ = 4 $\Omega$ , $I_D \cong$ 10 A,	-	6	12		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	20	40		
Fall time	t <sub>f</sub>		-	5	10	ns	
Turn-on delay time	t <sub>d(on)</sub>		-	18	36	115	
Rise time	t <sub>r</sub>	$V_{DD}$ = 40 V, $R_L$ = 4 $\Omega,I_D\cong$ 10 A,	-	18	36		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	21	42		
Fall time	t <sub>f</sub>		-	25	50		
Drain-Source Body Diode Characterist	cs					1	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	35.4	Α	
Pulse diode forward current	I <sub>SM</sub>		-	-	70		
Body diode voltage	V <sub>SD</sub>	$I_S = 5 A$ , $V_{GS} = 0 V$	-	0.77	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	30	60	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	26	52	nC	
Reverse recovery fall time	t <sub>a</sub>	T <sub>J</sub> = 25 °C	-	20	-	ns	
Reverse recovery rise time	t <sub>b</sub>		-	14	-	110	

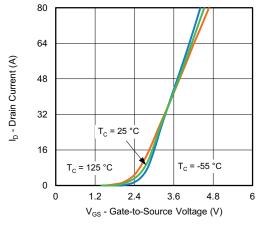
#### Notes

- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

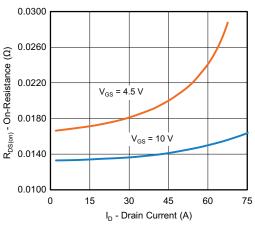


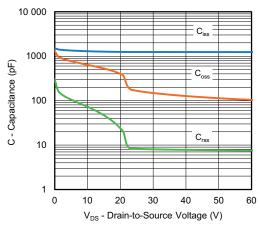






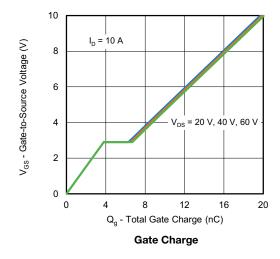


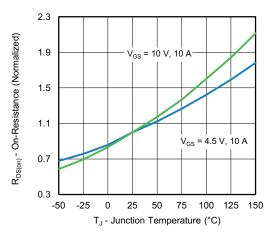




On-Resistance vs. Drain Current and Gate Voltage

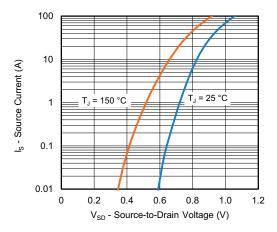
Capacitance



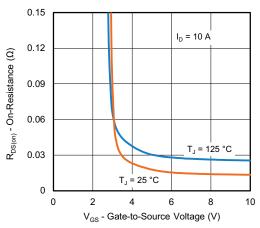


On-Resistance vs. Junction Temperature

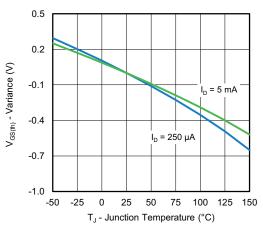




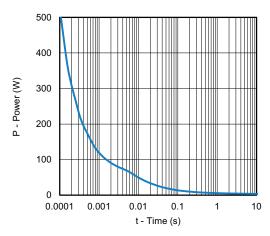
Source-Drain Diode Forward Voltage



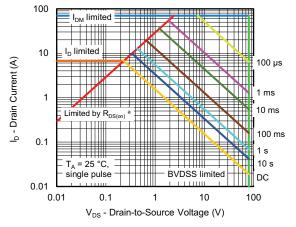
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient

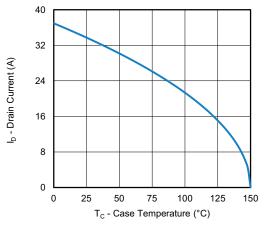


Safe Operating Area, Junction-to-Ambient

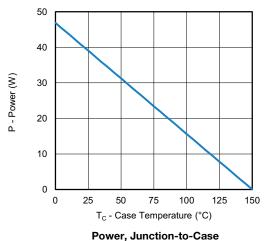
#### Note

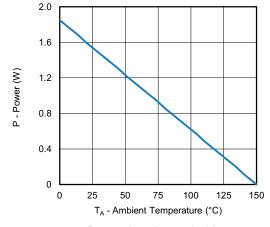
a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified





Current Derating a





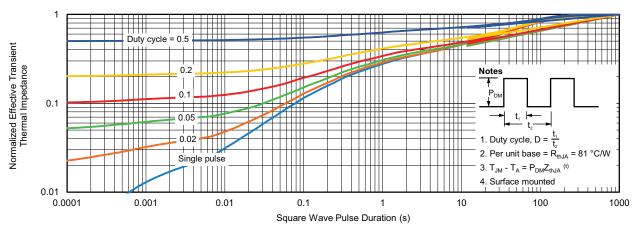
Power, Junction-to-Case

Power, Junction-to-Ambient

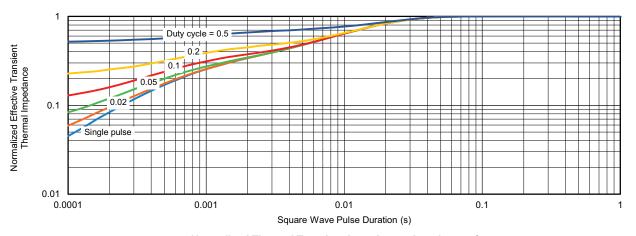
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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